

深圳市鑫永诚光电科技有限公司  
Shenzhen Newopto Photoelectric Technology Co., Ltd.

**产品承认书**  
**SPEC FOR APPROVAL**

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鑫永诚 PT850 红外 LED 是一款高灵敏度的光敏传感器，插件式外型封装，是传统 CDS 光敏电阻的理想替代产品。

NEWOPTO PT850 infrared LED is a high sensitivity optical sensor, in DIP package. It's the ideal substitute for traditional CDS photosensitive resistor.

### 特性 Features

- 1) 峰值波长 Peak wavelength  $\lambda_p=850\text{nm}$
- 2) 高可靠性 High reliability
- 3) 低功耗 Low Power Consumption
- 4) 符合 RoHS RoHS compliant

### 应用 Applications

- 1) 替代传统 CDS 光敏电阻 Replacement of conventional CDS photosensitive resistors
- 2) 适用于各类光控照明产品：如小夜灯等 Suitable for all kinds of light products: such as night lamp etc.
- 3) 自动调节背景光：如 LCD、手机、照像机、电脑摄像头等 Products which need to adjust background light automatically, LCD, mobile phone, camera, computer camera etc.
- 4) 控制各类光控影控玩具 Control all kinds of light and shadow controlled toys
- 5) 各类光控红外检测测试设备等 All kinds of infrared light detection and testing equipment

### 量身订制 Customization

- 1) 品种齐全,生产周期短,小批量库存备货  
Complete varieties, short production cycle, small batch inventory
- 2) 可按要求提供不同外型,角度,方便安装于产品的任何位置  
Customize different shapes and angles
- 3) 可按需求提供最佳的规格,以便让产品效果更好,更具市场竞争力  
Customize most suitable specifications to make the product be more competitive

**极限参数 Absolute Maximum Ratings at (Ta=25°C)**

电气特性 Electrical characteristics	Symbol	Rated Value	Unit
集电极—发射极电压 Collector-emitter Breakdown Voltage	V <sub>CEO</sub>	30	V
发射极—集电极电压 Emitter-Collector Breakdown Voltage	V <sub>ECO</sub>	6	V
功耗 Power	PC	70	mW
工作温度 Operating Temperature	Topr	-30--+85	°C
储存温度 Storage Temperature	Tstg	-40--+100	°C

**光学特性 Optical Characteristics (Ta=25°C)**

参数 Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
感光峰值波长 Photosensitive peak wavelength	$\lambda_p$	\	--	850	--	nm
感光波宽范围 Sensitivity wave width	$\lambda$	\	700	--	1100	nm
集电极—发射极电压 Collector-emitter Breakdown Voltage	B <sub>vceo</sub>	I <sub>C</sub> =100 $\mu$ A E <sub>e</sub> =0mW/cm <sup>2</sup>	30	--	--	V
发射极—集电极电压 Emitter-Collector Breakdown Voltage	B <sub>vceo</sub>	I <sub>E</sub> =10 $\mu$ A E <sub>e</sub> =0mW/cm <sup>2</sup>	6	--	--	V
集电极发射极饱和电压 Collecto Emitter saturation voltage	V <sub>ce</sub> (sat)	I <sub>C</sub> =2mA E <sub>e</sub> =1mW/cm <sup>2</sup>	--	--	0.4	V
光电流 Photocurrent	I <sub>L</sub> (1)	V <sub>CE</sub> =5V E <sub>e</sub> =1mW/cm <sup>2</sup>	1.0	1.6	2.4	mA
暗电流 dark current	I <sub>ceo</sub>	V <sub>CE</sub> =5V E <sub>v</sub> =0Lux	--	--	0.1	$\mu$ A
开启时间 Opening time	t <sub>r</sub>	V <sub>CE</sub> =5V I <sub>C</sub> =1mA	15			us
关闭时间 Closing time	t <sub>f</sub>	RL=1000 $\Omega$	15			

**可靠性试验 Reliability Test**

测试项目 Test Parameter	参考标准 Reference Criterion	测试条件 Test Condition	时间 Time	样品数 Quantity	Ac/Re
耐焊接热 Resistance to Soldering Heat	JESD22-B106	260°C±5°C	10 sec	22PCS	0/1
冷热循环 thermocycling	JESD22-A104	+100°C(15min) 5min -10°C(15min)	50 cycles	22PCS	0/1
冷热冲击 Thermal Shock	JESD22-A104	+105°C(30min) 5min -45°C(30min)	50 cycles	22PCS	0/1
高温贮存 High Temperature storage	JESD22-A103	+100°C	1000H	22PCS	0/1
低温贮存 Low Temperature storage	JESD22-A119	-40°C	1000H	22PCS	0/1
寿命测试 Operating Life	JESD22-A108	VCE=5V	1000H	22PCS	0/1
高温高湿 High Temperature High Humidity	JESD22-A101	85°C/85%	168H	22PCS	0/1

**光电特性曲线 Typical photoelectric characteristics curves**

感光特性曲线 Photographic property Curve

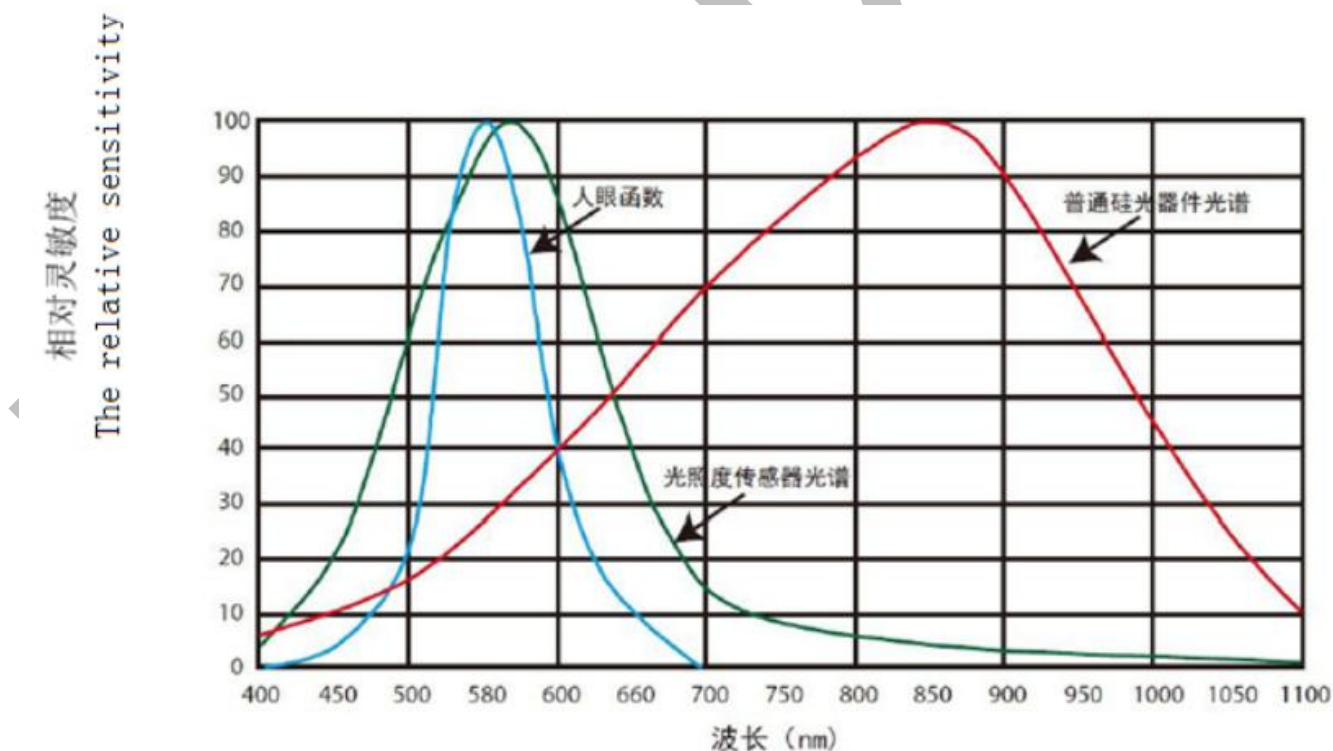
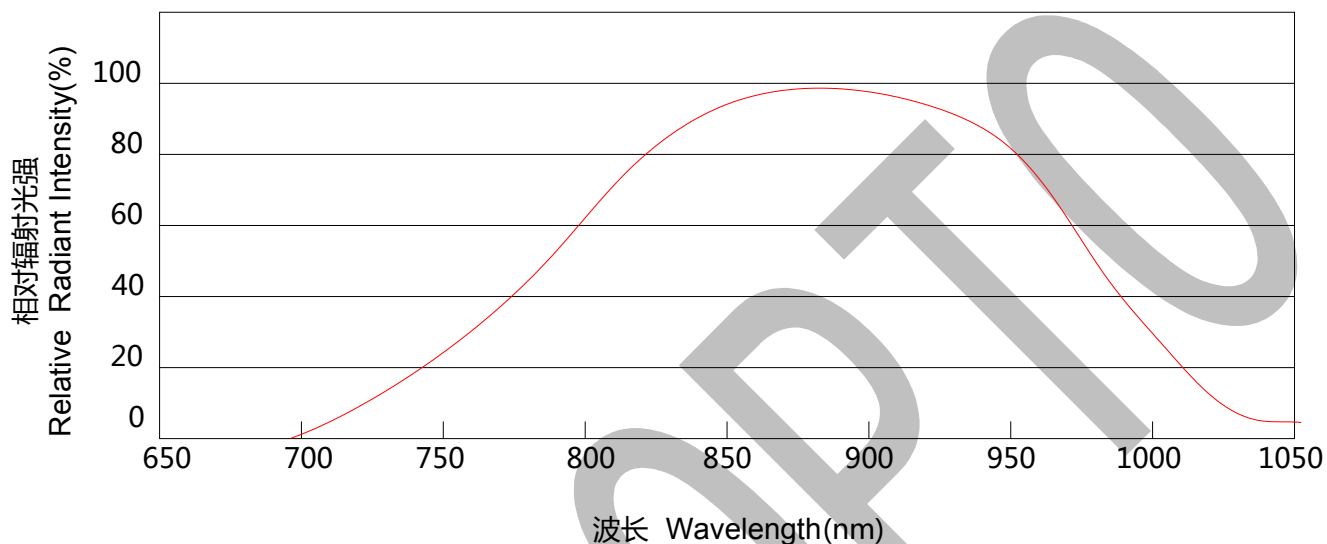


图 1-1 Photoreceptor curve XYC/PT850 Visible light sensor curve

**Environment Temperature VS Dark Current**

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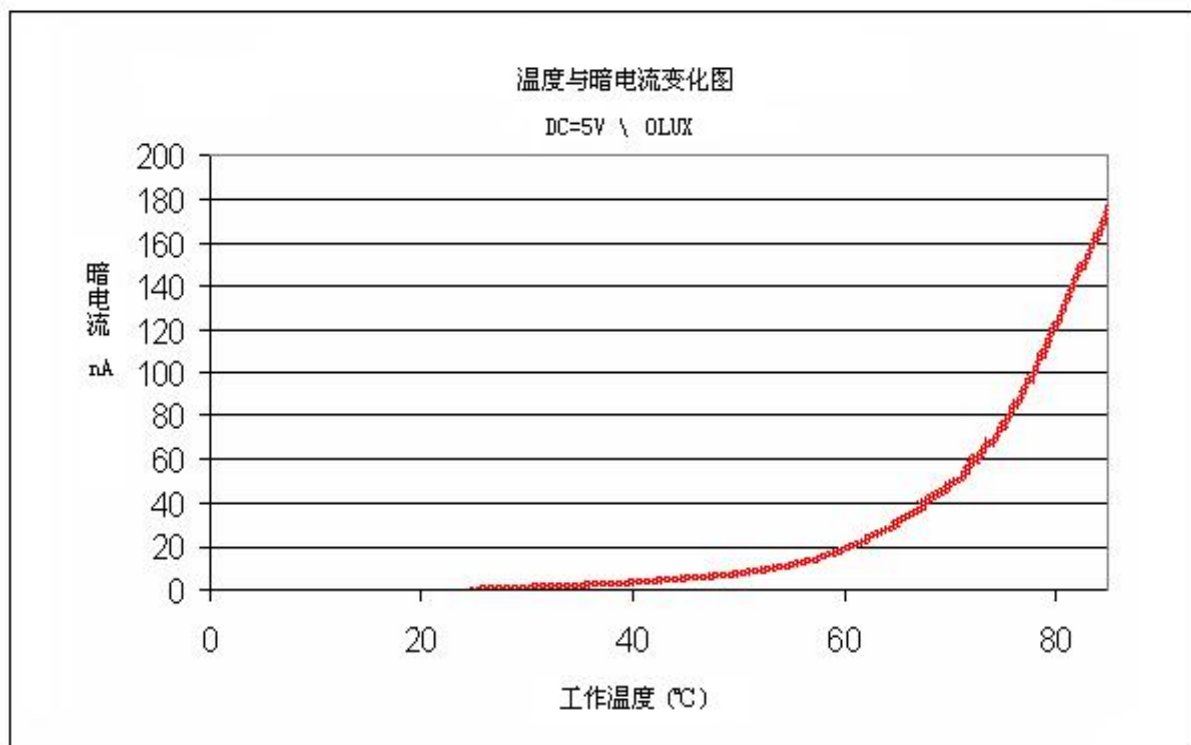
Add : Bldg 1,3rd Phase,Fu'an Industrial City,Dayangtian,Fuyong Town,Baoan District,Shenzhen,China

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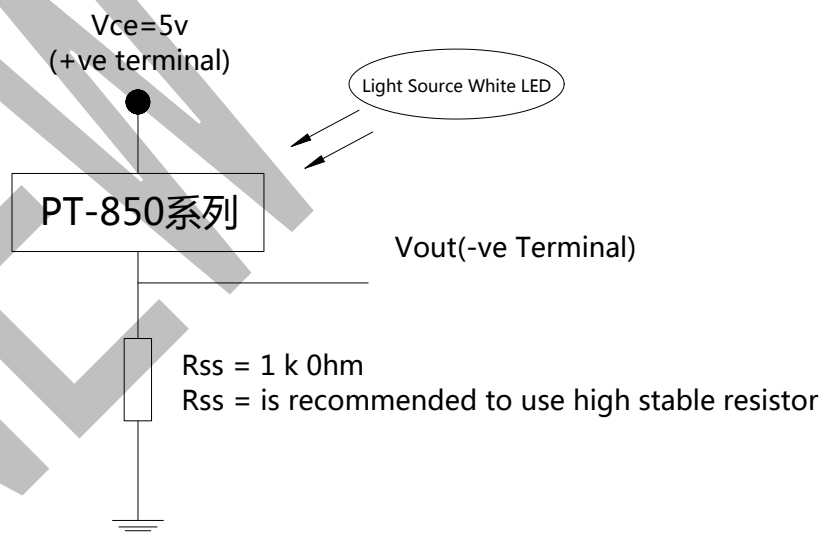
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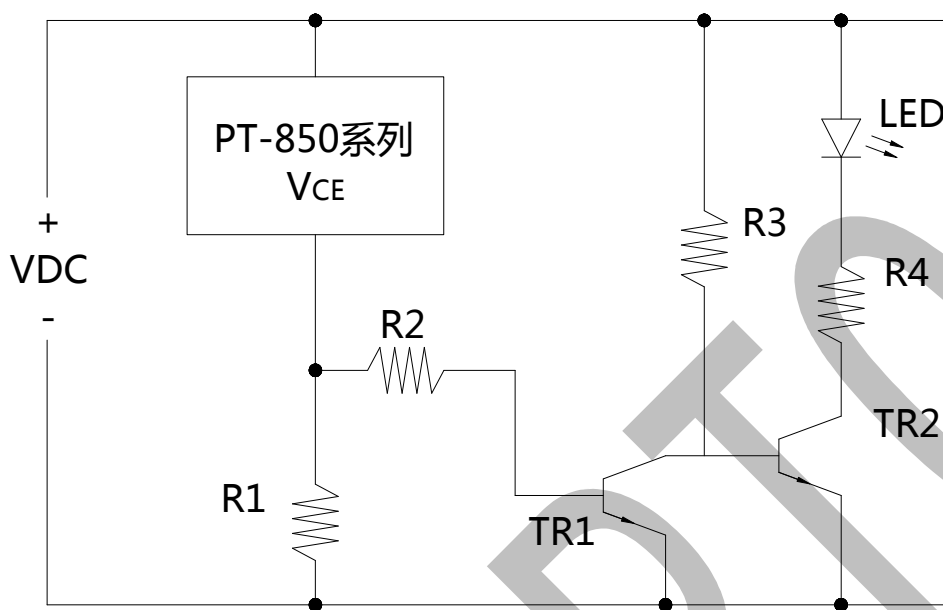
邮箱(E-mail):[xycgd888@163.com](mailto:xycgd888@163.com)



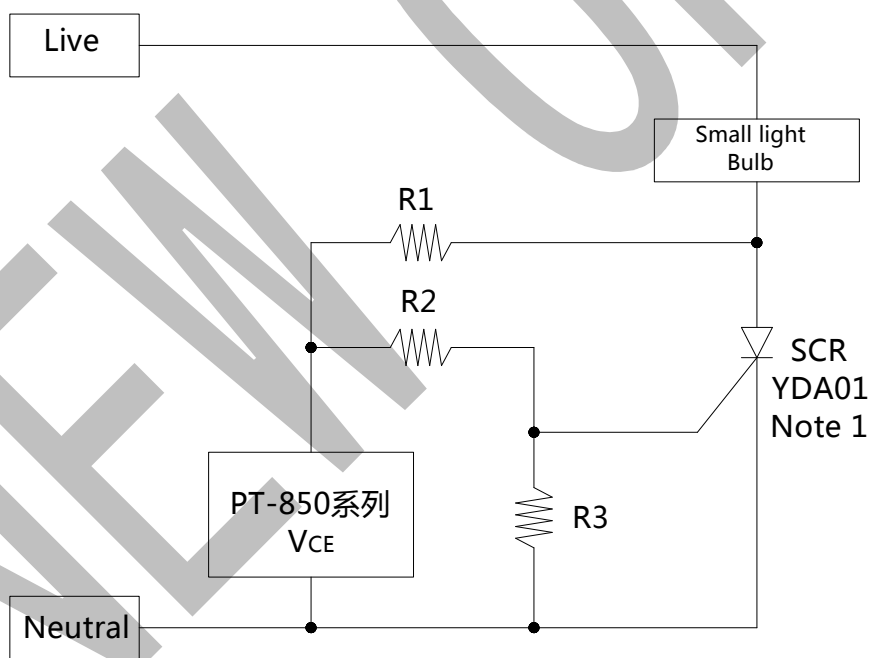
一般应用示意图



LED通用驱动电路



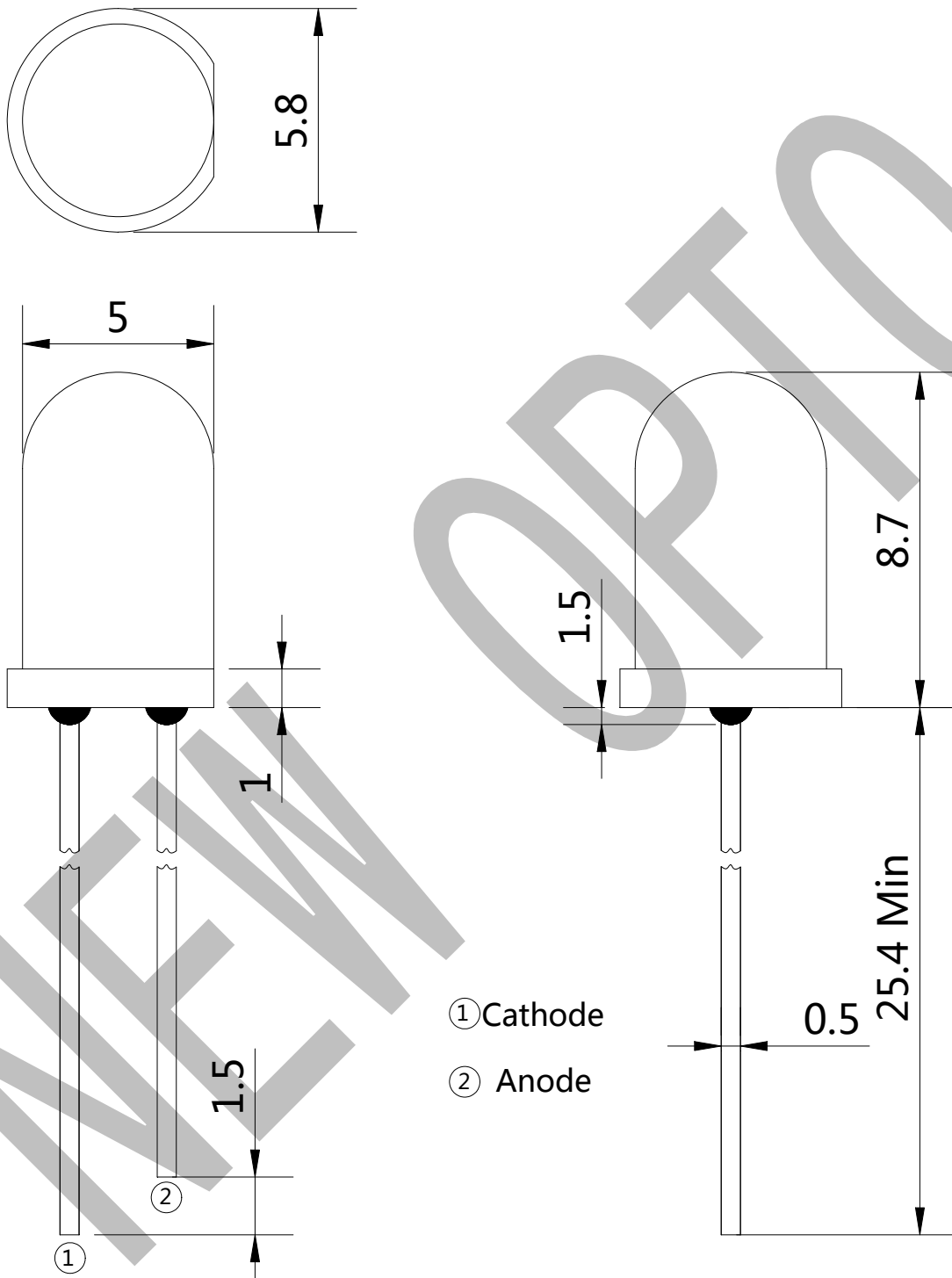
当光照低于光照阈值时，TR1三极管关闭，TR2三极管导通，LED导通。当环境光照大于光照阈值时，TR1降低的电流并使TR2截止，LED不导通。



该电路需要一个敏感的可控硅。灯泡的电流是由敏感的可控硅开关空置。当光量超过阈值时，该VC与VE引脚之间的电流转移了可控硅的栅极电流。光切换阈值可通过选择R2和R3不同的值进行调整。



产品外型尺寸 Package outline dimensions



备注：所有尺寸单位均为 mm，如无特殊说明误差范围为±0.15mm

Note : All dimensions in mm,tolerance is ±0.15mm unless otherwise noted

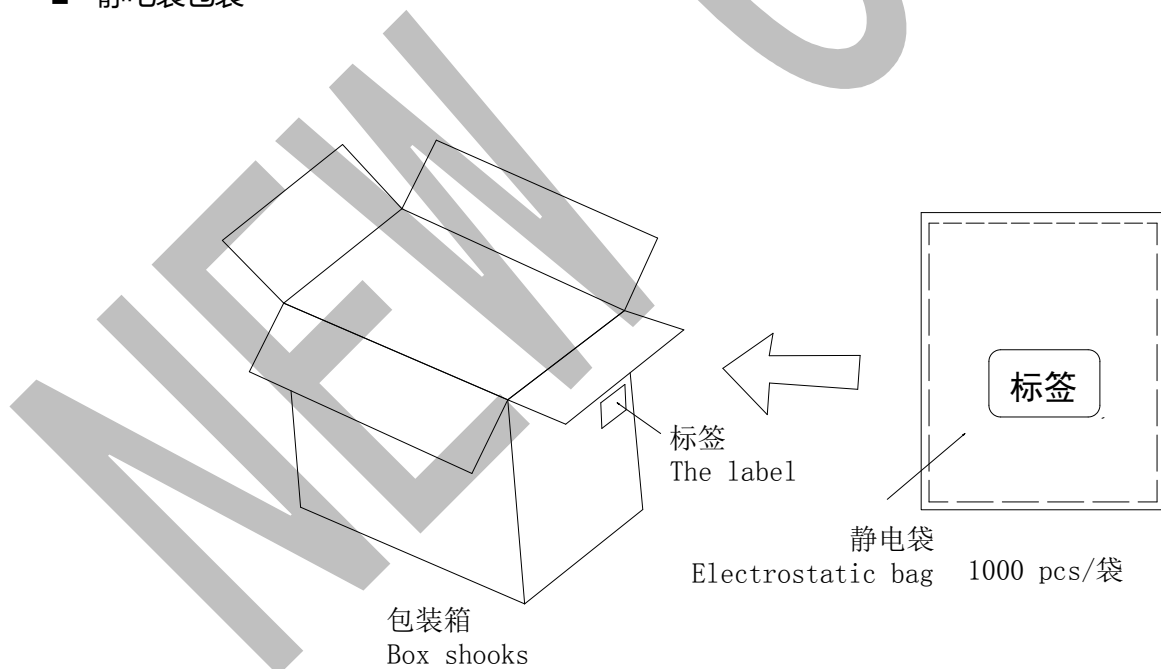
**包装规格 Packing Specification**

■ 标签规格 Label specification

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<a href="http://www.xycgd.com">http://www.xycgd.com</a>	
料号	Material Number
型号	Model Number
单号	Lot.Number
箱号	Box Number
数量	Quantity
日期	Date



■ 静电袋包装



## 焊接 Soldering

焊接过程中的不慎操作将会引起产品的损坏,请务必注意。焊接过程中应避免对产品支架或封装部分施加压力。焊接时,请保证焊接位置与封装树脂底部有一定的距离,该距离因不同的焊接方法而有所不同,请参照以下推荐焊接条件。

Damages may be caused during soldering, please be careful. Please note that don't put stress on product bracket and package part when soldering. And make sure keep some distance from soldering joint to the bottom of epoxy package when soldering. The distance is determined by different soldering techniques, it's recommended to take following soldering conditions as reference.

### 推荐焊接条件 Recommended Soldering Conditions

焊接模式 Mode		固定形式 Fixed form
手工焊接 Manually Soldering	烙铁温度 Soldering Iron Temperature	最高温度 300°C(功率最大 30 瓦) Max 300°C (power:30w Max)
	焊接时间 Soldering Time	时间不超过 3 秒 3 sec Max
	焊接位置 Soldering Position	大于 3mm (从焊点到胶体) 3mm Min.(Form soldering joint to colloid)
波峰焊接 Wave Soldering	预热 PreHeat	最高温度 100°C 不超过 60 秒 100°C Max.60 sec.Max
	温度 Temperature	最高 260°C 260°C Max.
	焊接时间 Soldering Time	不超过 5 秒 5 sec Max
锡炉焊接 Solder pot Soldering	预热 PreHeat	最高温度 100°C 不超过 60 秒 100°C Max.60 sec.Max
	浸焊温度 PreHeat Temperature	最高 260°C 260°C Max.
	浸焊时间 Soldering Time	不超过 5 秒 5 sec Max
	焊接位置 Soldering Position	大于 2mm (从焊点到胶体) 2mm Min.(Form soldering joint to colloid)

- 本产品不适合做回流焊接。  
It's unsuitable for reflow soldering.
- 手工焊接只可焊接一次。  
Manually soldering should be done once only.
- 器件外部温度在 40°C 以下时，才可以对其进行处理。避免高温时操作对 LED 造成损伤。  
Handling of the SMD LED should be done when the package has been cooled down to below 40°C or less. This is to prevent LED failures due to thermal-mechanical stress during handling.  
Please solder the LED under 40 degree to avoid high temperature damage the device.
- 在焊接温度回到正常以前，必须避免使 LED 受到任何震动或外力  
After soldering the LED should avoid any shake or outer force before it come to normal temperature
- 在焊接后推荐使用酒精进行清洗，在温度不高于 30°C 的条件下持续 1 分钟，不高于 50°C 的条件下持续 30 秒。使用其他类似溶剂清洗前，请先确认使用的溶剂不会对 LED 的封装和环氧树脂部分造成损伤。  
It is recommended that alcohol be used as the solvent for cleaning after soldering. Cleaning should be done under 30°C for 3 minutes or 50°C for 30 seconds. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not.

注意：此一般指导原则并不适用于所有 PCB 设计和焊接设备的配置。具体工艺受到诸多因素的影响，请根据特定的 PCB 设计和焊接设备来确定焊接方案。

Note : This general guideline may not suitable for all PCB designs or configurations of all soldering equipment. The technique in practice is influenced by many factors, it should be specialized base on the PCB designs and configurations of the soldering equipment.

## 使用注意事项 Precautions

感谢您使用深圳市鑫永诚光电科技有限公司的系列 LED 产品，为增进您对我公司产品特性的了解，也为方便您快速掌握产品的基本操作，为尽量减少或避免因人为等因素造成不必要的产品损坏，使其能够更好的为您的生产服务，特针对使用过程中的一些规范使用作相应说明，同时即使是同一规格 LED，在实际应用领域其可靠性与整体系统设计水平、作业方式、使用条件均相关。本使用说明不可能涵盖客户使用过程中可能碰到的所有问题，由此带来的不便，敬请谅解！

Thanks for using relevant LED products of Shenzhen Newopto Photoelectric Technology Co., Ltd. In order to enhance your understanding of the characteristics of our products, as far as reduce and avoid unnecessary damage to the product due to man made factors ,and make it service your production better , we give corresponding instructions according to the characteristic in the process of standard use. At the same time, even if the same specifications LED, its reliability are related to overall system design level ,mode of operation and conditions of use in the practical application field . This Instructions didn't cover all questions customers may encounter during using, we sincerely apologize for any inconvenience this may cause !

### ■ 产品声明 Product Declaration

- 使用本产品之前，请贵司务必预先进行测试，以便确认是否适合使用目的，产品介绍的用途并不保证不抵触任何专利，有关 LED 产品的进出口法律责任应由客户担负，请预先查清每个国家或地区的有关规定，产品可能会因性能提高或规格参数改变等缘故，恕不经预告更改，我们要求量产前签订正式的产品规格书

In order to confirm if the product is right for using purpose , pretest is necessary before use . The product application introduction may contravene any patent. The corresponding import and export legal responsibility should be taken by customers. Please verify relevant provision about the LED product in your Target market beforehand. we may change specifications from time to time in the interest of product development,without prior notification or public announcement. An agreement of formal product specifications is required prior to mass production.

### ■ 储存 Storage

- 在温度不高于 30℃，湿度不高于 60%RH 的条件下，产品保存期限为 6 个月。将产品保存在密封的容器中并附带干燥剂可以在一定程度上延续产品的储存日期。不良的储存条件会导致产品引脚的腐蚀或产品性能的改变。

Under the storage conditions of 30°C or less and humidity less than 60%RH, the LEDs storage period is 6months. Stored in a sealed container with moisture absorbent , storage time can be prolonged to a certain extent .Bad storage conditions may cause the LED pin corrode or LED characteristics be changed. It is recommended that the LEDs be used as soon as possible.

- 开封后,产品必须 24 小时内使用完(建议工作环境温度不高于 30℃,湿度不高于 60%),如未使用完,余料须存放在温度不高于 30℃,湿度不高于 10%的环境中。

After opening the package, the product should be soldered within 24 hours. If not, please store at 30°C or less and humidity less than 10%RH. It is recommended that the product be operated at the workshop condition of 30°C or less and humidity less than 60%RH.

- 对于尚未焊接的 LED,如果吸湿剂或包装失效,或者产品没有符合以上有效存储条件,烘烤可以起到一定的性能恢复效果. 烘烤条件:65±5℃.持续时间 24H.

For the LED doesn't soldered, if the moisture absorbent material lose efficacy or the storage condition doesn't conform to the above description, baking can help some extent performance recovery. Baking condition:  $65\pm 5^{\circ}\text{C}$  for 24 hours.

#### ■ 静电 Static electricity

- 静电和电涌会导致产品特性发生改变, 例如正向电压降低等, 如果情况严重甚至会损毁产品, 所以在使用时必须采取有效的防静电措施。所有相关的设备和机器都应该正确的接地, 同时必须采取其他防静电和电涌的措施。使用防静电手环, 防静电垫子, 防静电工作服, 工作鞋, 手套, 防静电容器, 都是有效的防止静电和电涌的措施。

Static and electric surge would change the features of LED, such as decreasing of forward voltage. Even damages may occur in serious conditions. Please make sure adopt effective anti-static measures. All the relative devices and machinery must be properly grounded. At the same time, it is recommended to use anti-static wrist bands, anti-electrostatic gloves, anti-electrostatic containers and so on to prevent static and electric surge.

#### ■ 设计建议 Design Suggestion

- 设计电路时, 加载在光敏管 LED 两端的电压不能超过规定的最大值, 同时还需要使用分压电阻, 以便产品在有光照的情况下将电流变化转换为电压变化, 以电压变化进行结果输出从而达到电路控制的效果。

When design the circuit, the voltage loaded on the both ends of the photosensitive LED tube should not exceed the specified maximum value, and the pressure resistance should be used to let product convert current change to voltage changes during illumination, in that to achieve the effect of control circuit.

- 光敏管 LED 的特性容易因为其他电子元件的发热和环境的温度的改变而发生变化。温度的升高会使电子的漂移运动加剧增大暗电流, 影响原先产品的电路设计, 所以在设计时应充分考虑散热的问题和使用环境的问题。

The characteristics of photosensitive LED tube are easily to be effected by the heat of other electronic components and the temperature changes of environment. High temperature would intensify the electrons drift motion then cause dark current increases and affect the original circuit design. So the design should take full account of the heat problem and environment problem.

#### ■ 支架整形 Lead Forming

- 支架的整形必须在焊接之前进行。整形时, 支架的弯曲位置必须至少在封装树脂底部 3mm 处, 同时避免对同一位置进行多次的弯曲。

Any lead forming must be done before soldering, not during or after soldering. When forming leads, the leads should be bent at least 3mm from the base of the expose bulb. Avoid bending at the same position twice or even more.

- 整形时请使用合适的工具固定支架, 避免对树脂施加压力。特别是不能管脚与树脂的连接部分作为支点, 这样产生的应力会直接对产品内部的发光结构造成损伤, 导致产品特性的改变甚至损毁。

Please use proper tools to hold the leads. Avoid put press on resin especially don't regard connection part of pin and resin as fulcrum, the pressure caused by it would damage the inner part of product illumination structure, and would change the characters or even damage of the product.

- 基于同样的原因, 在装配产品的时候, PCB 板上焊孔间的距离必须于产品的管脚间距严格匹配。

For the same reason, when mounting the LED on to printed circuit board, the holes on the circuit board should be exactly aligned with the leads of the LED.

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